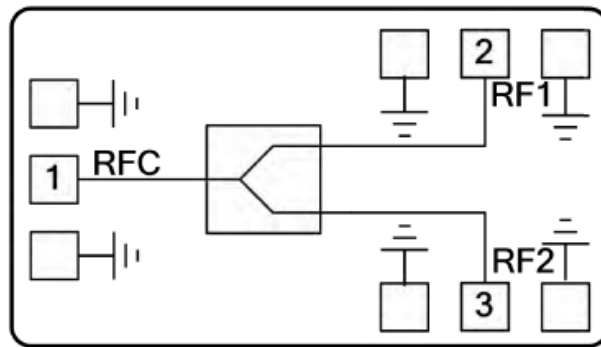




### Features

- Frequency: 8-12GHz
- Insertion Loss: 0.3dB Typical
- Isolation: 30dB Typical
- Input/Output: 50Ω
- Chip Size: 1.154 x 1.561 x 0.1mm

### Functional Block Diagram



### Typical Applications

- Test Instrumentation
- Microwave Radio & VSAT
- Military & Space
- Telecom Infrastructure
- Fiber Optics

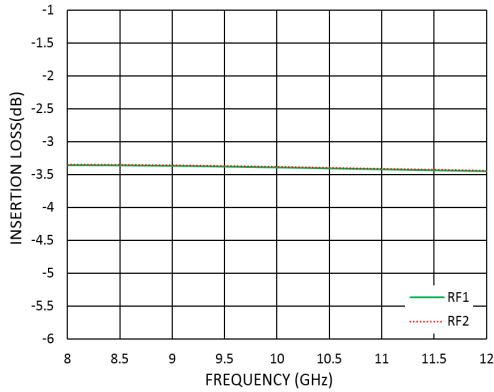
### Electrical Specifications

TA = +25°C ,Pin=0dBm

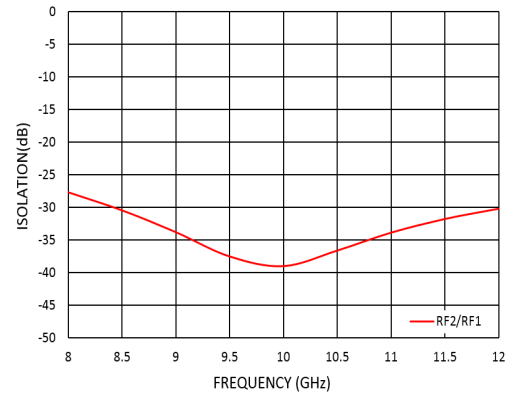
Parameters	Min.	Typ.	Max.	Units
Frequency	8		12	GHz
Nominal Splitter Loss		3		dB
Insertion Loss		0.3	0.5	dB
Insertion Loss Flatness		±0.1		dB
Isolation	25	30		dB
Input Return Loss	21	25		dB
Output Return Loss	22	27		dB



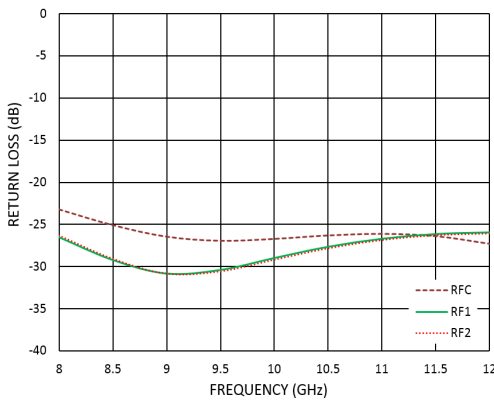
### Insertion Loss vs. Frequency

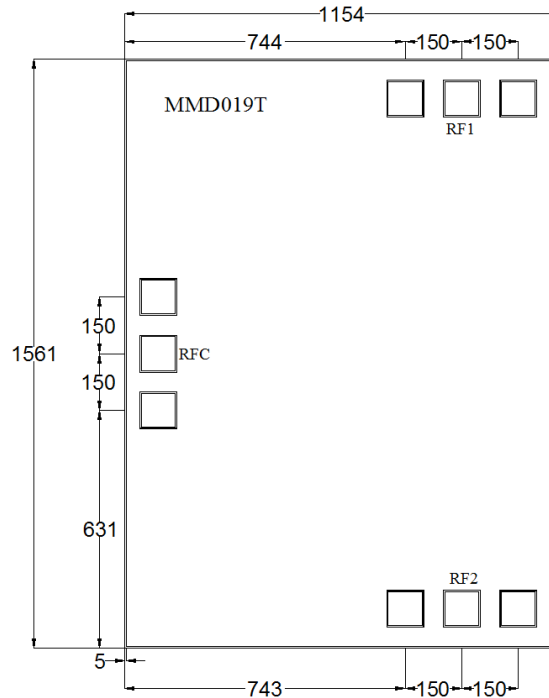


### Isolation vs. Frequency



### Return Loss vs. Frequency



**Outline Drawing: All Dimensions in  $\mu\text{m}$** 

**Absolute Maximum Ratings**

RF Input Power	+40dBm
Operating Temperature	-55°C to +85 °C
Storage Temperature	-65°C to +150 °C

No	Symbol	Description
1	RFC	RF Common Port
2,3	RF1&RF2	RF Branch Ports

**Notes:**

1. Die thickness: 100 $\mu\text{m}$
2. RF IN/OUT bond pad is 100\*100 $\mu\text{m}^2$
3. Bond pad metalization: Gold
4. Backside metalization: Gold
5. Backside of the die (GND)

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